



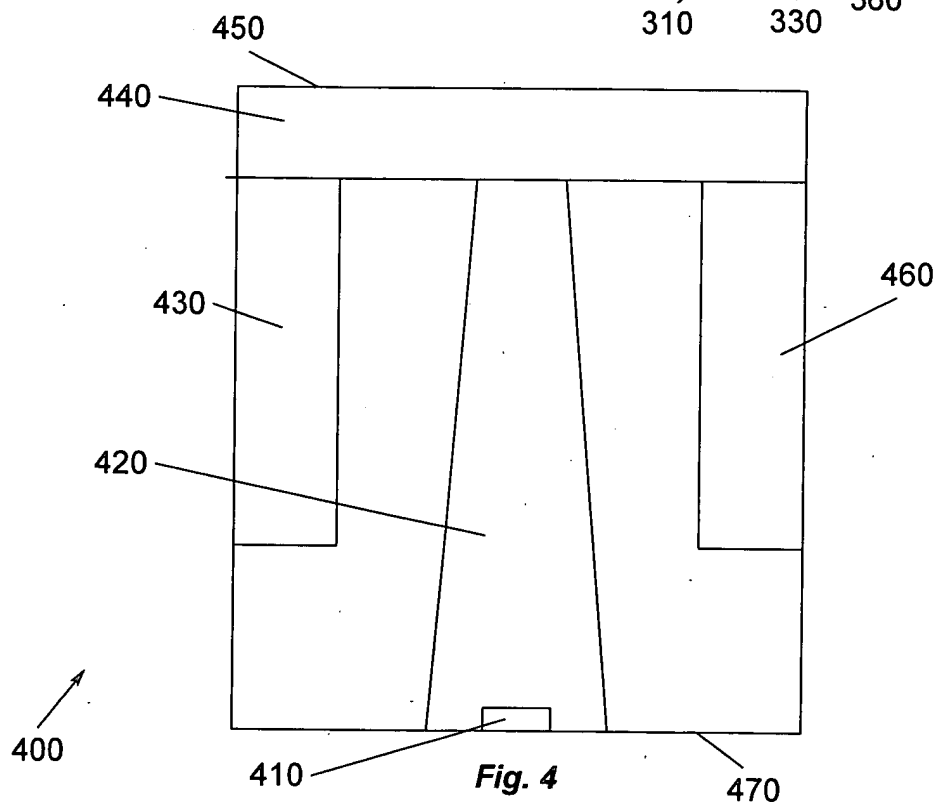
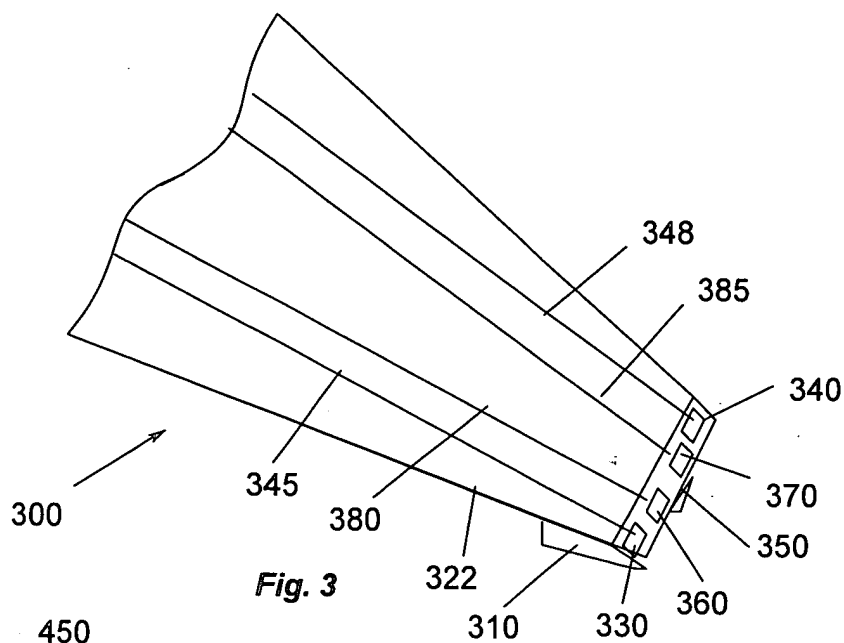
Title: METHOD AND APPARATUS FOR ENHANCING THERMAL STABILITY, IMPROVING BIASING AND REDUCING DAMAGE FROM ELECTROSTATIC DISCHARGE IN SELF-PINNED ABUTTED JUNCTION HEADS HAVING A FIRST SELF-PINNED LAYER EXTENDING UNDER THE HARD BIAS LAYERS

Applicants: Gill, et al.

Docket: HSJ920030016US2/HITG.054PA

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REPLACEMENT SHEET





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REPLACEMENT
SHEET

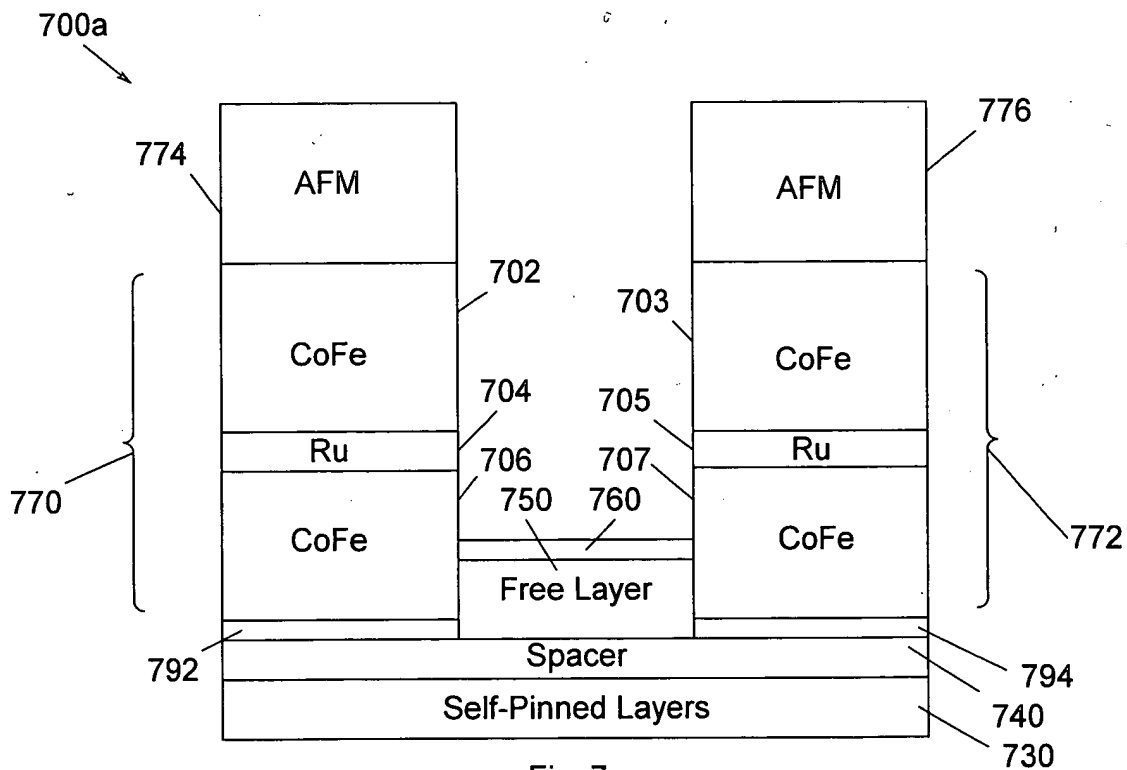


Fig. 7a

Title: METHOD AND APPARATUS FOR ENHANCING
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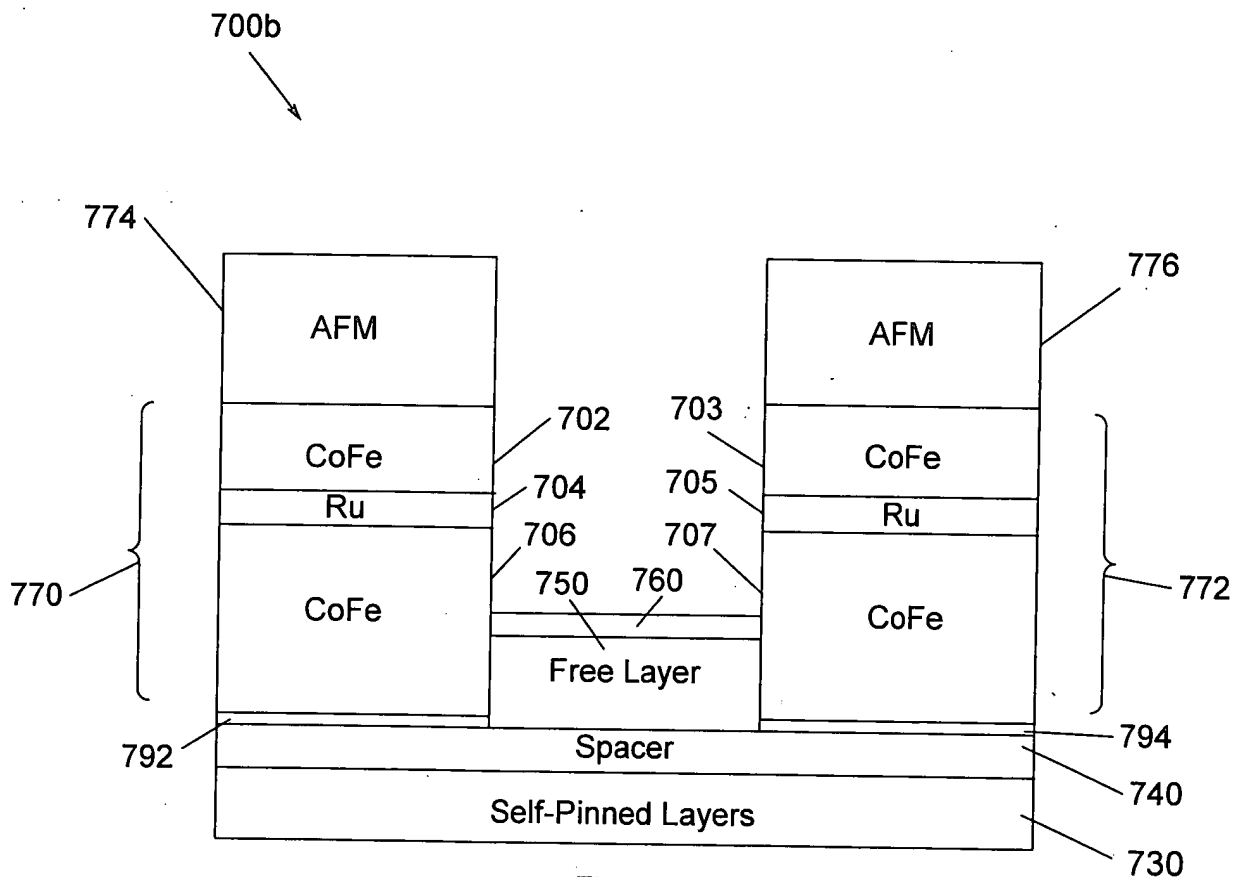


Fig. 7b